ASSOCIATION CONNECTING ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	IPC. Bannockł	ourn, Illinois, A	Il rights reserved untions.	under both	This docum level parts, t	ent is a declarati the declaration e	on of the su	ibstances v s all lower	within the manufactu level materials for v	which the	item. Note manufactur	: if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and					rials and N	Ifg Inform	ation		
Supplier Information														
Company name* Compa			ompany unique ID			Unique ID Authority				Respor	Response Date*			
nsemi								2024-05-21						
ontact Name Title - Contact			ct		Phone - Contact*				Email - Contact*					
Product-Env-Stewards Product Enviro			ro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representati			entative		Phone - Representative*			Email	Email - Representative*					
Product-Env-Stewards Product Enviro Con			o Compliance		NA			Produ	Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date	Version	M	Manufacturing Site		Weight*	UOM	Unit Type	
	ESD700	ESD7008MUTAG 8 LINE F		INE ESD PROTECTION		2024-05-21		M	MY1		10.8	mg	Each	
Aanufacturing Proccess Informa	ation											· · ·		
Terminal Plating / Grid Array M	laterial 7	Ferminal Base	lloy J-STD-020 MSL Rat		L Rating	Peak Proc	eak Process Body Temperatu		ure Max Time at Peak Temp		ture Nun	nber of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.22	mg	Supplier	Silicon (Si)	7440-21-3		0.22	mg
Die Attach	0.01	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.004	mg
			Supplier	Silver (Ag)	7440-22-4		0.006	mg
Lead Frame	1.85	mg	Supplier	Silver (Ag)	7440-22-4		0.037	mg
			Supplier	Tin (Sn)	7440-31-5		0.0046	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0041	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0046	mg
			Supplier	Copper (Cu)	7440-50-8		1.7997	mg
Mold Compound-Black	8.03	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.6424	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0401	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1606	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		6.946	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.2409	mg
Plating	0.47	mg	Supplier	Tin (Sn)	7440-31-5		0.47	mg
Wire Bond - Au	0.22	mg	Supplier	Gold (Au)	7440-57-5		0.22	mg